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Atty. Docket No. CPAC 1014-4
Appl. No. 10/608,843

JUN 23 2005

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Taekun LEE *et al.*

Application No.: 10/608,843

Filed: June 27, 2003

Title: (Amended) Method for manufacturing
plastic ball grid array with integral
heatsink

Examiner: Khiem D. Nguyen

Group Art Unit: 2823

Date: June 23, 2005

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to
Examiner Nguyen in the United States Patent and Trademark Office, at the
Central Fax no. 703-872-9306 on June 23, 2005.

Signed

Bill Kennedy

COMMISSIONER FOR PATENTS
P.O. Box 1450
ALEXANDRIA, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Advisory Action mailed 22 June 2005, kindly amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the Listing of Claims which begins on page 3 of this paper.

Remarks begin on page 5 of this paper.

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